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THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

TI-31089

Mahalingam Nandakumar, et al.

Examiner: Edgardo Ortiz

Serial No: 09/876,292

Art Unit: 2815

Filed:

06/07/01

For:

Additional n-Type LDD/Pocket Implant for Improving Short-Channel NMOS ESD

Robustness

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97 & 1.98

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)

I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Karen Vertz

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Dear Sir:

In the matter of the above-identified application, Applicant is submitting herewith copies of documents listed in the attached form equivalent to Form PTO-1449 for the Examiner's consideration.

In accordance with 37 CFR 1.97 (d), this Information Disclosure statement is being submitted before payment of the issue fee and is accompanied by the fee of \$130.00 set forth in 37 CFR 1.17(i), and the following certification specified in 37 CFR 1.97(e).

On information and belief, I hereby certify that each item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent

office in a counterpart foreign application not more than three months prior to the filing of this statement.

Pursuant to 37 CFR 1.97(d), Applicant respectfully petitions that this Information Disclosure Statement be considered by the Examiner.

Please charge any shortage in the fees due in connection with the filing of this paper, includes extension of time fees, to the Deposit Account No. 20-0668 of Texas Instruments Incorporated, and please credit any excess fees to such Deposit Account. **This form is submitted in triplicate.**

Respectfully submitted,

Gary C. Honeycutt

Attorney for Applicants

Reg. No. 20,250

Texas Instruments Incorporated P.O. Box 655474, MS 3999 Dallas, TX 75265 (972) 470-0130

TI-31089

+ Approved for use through 10/31/2002. OMB 0651-0031 a plus sign (+) inside this box A Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE nder the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number. Complete If Known Substitute for Form 1449A/PTO 09/876,292 Application Number 06/07/01 Filing Date PINFORMATION DISCLOSURE First Named Inventor Mahalingam Nandakumar, et al. STATEMENT BY APPLICANT Group Art Unit 2815 Edgardo Ortiz **Examiner Name** (use as many sheets as necessary)

Attorney Docket No.

Sheet

				U.S. I	PATENT DOCUME	ENTS
	Cite No. ¹	U.S. Patent Document		Name of Patentee	Date of Pub.	
Exam. Initials*		Number	Kind Code ² (if known)	or Applicant of Cited Doc.	of Cited Doc. (mm-dd-yyyy)	Pages, Columns, Lines, Where Relevant Passages or Relevant Figur Appear
	AA	5,023,678		Kinzer	6/11/91	
	AB	5,371,394		Ma et al.	12/6/94	
-	AC	6,174,778		Chen et al.	1/16/01	
	AD					
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	FOREIGN PATENT DOCUMENTS								
Exam. Initials*	Cite No.1	Foreign Patent Document			Name of Patentee	Date of Pub.			
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	ВА	FR	2 796 204 A1		Alieu Jerome et al.	1/12/01			
	ВВ								
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OTHER PRIOR ART - NON PATENT LITERATURE DOCUMENTS						
Exam. Initials*	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.				
	CA	KUNIKIYO TATSUYA, "Semiconductor Device and Its Manufacture" Patent Abstracts of Japan, Vol. 1995, No. 02, March 31, 1995, Publication Number 06318698, Publication Date November 15, 1994				
	СВ	MORII TOMOYUKI, "MOS Type Semiconductor Device and Manufacture Thereof" Patent Abstracts of Japan, Vol. 014, No. 346, July 26, 1990, Publication Number 02119269, Publication Date May 7, 1990				
	СС					
	CD					
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Signature	 Considered	<u> </u>

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^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.